

D8KB05~D8KB100

Single Phase 8.0Amp Glass passivated Bridge Rectifiers

Features

- Glass passivated chip
- Low forward voltage drop
- Ideal for printed circuit board
- High surge current capability

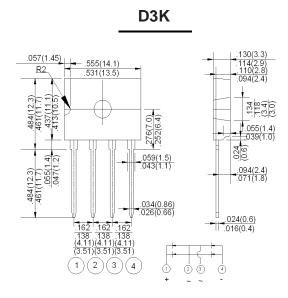
Mechanical Data

• Polarity: Symbol marked on body

• Mounting position: Any

Applications

 General purpose use in AC/DC bridge full wave rectification, for SMPS, lighting ballaster, adapter, etc.



Package Outline Dimensions in Inches (Millimeters)

Maximum Ratings And Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified. Single phase half-wave 60Hz,resistive or inductive load, for capacitive load current derate by 20%.

| Characteristics | Symbol | D8KB05 | D8KB10 | D8KB20 | D8KB40 | D8KB60 | D8KB80 | D8KB100 | Unit |
|--|------------------|-------------|--------|--------|--------|--------|--------|------------------|------------|
| Maximum Repetitive Peak Reverse Voltage | VRRM | 50 | 100 | 200 | 400 | 600 | 800 | 1000 | V |
| Maximum RMS Voltage | VRMS | 35 | 70 | 140 | 280 | 420 | 560 | 700 | V |
| Maximum DC Blocking Voltage | VDC | 50 | 100 | 200 | 400 | 600 | 800 | 1000 | V |
| Maximum Average Forward Rectified Current | Ivasa | 8 | | | | | | | А |
| @TC=125 °C (with heatsink) | I(AV) | | | | | | | | |
| Peak Forward Surge Current, 8.3mS Single Half Sine-Wave, | Isou | 170 | | | | | | | А |
| Superimposed on Rated Load (JEDEC Method) | IFSM 170 | | | | | | | | |
| I ² t Rating for Fusing (t<8.3mS) | l ² t | 119.9 | | | | | | A ² s | |
| Peak Forward Voltage per Diode at 4.0A DC | VF | 1.0 | | | | | | | V |
| Typical Thermal Resistance to Ambient(Note1) (with heatsink) | Rеја | 12 | | | | | | | |
| Typical Thermal Resistance to case (Note1) (with heatsink) | Rejc | 2.5 2 | | | | | | | °C/W |
| Typical Thermal Resistance to lead(Note1) (with heatsink) | Rejl | | | | | | | | |
| Maximum DC Reverse Current at Rated @TJ=25°C | ls. | 5.0 | | | | | | | μA |
| DC Blocking Voltage per Diode @TJ=125℃ | lR | 500 | | | | | | | |
| Operating Junction Temperature Range | TJ | -55 to +150 | | | | | | | °C |
| Storage Temperature Range | Тѕтс | -55 to +150 | | | | | | | $^{\circ}$ |

Note: 1. Device mounted on 75mm*75mm*1.6mm Cu plate heatsink.

2. The typical data above is for reference only .



Ratings And Characteristic Curves

